

CALENDAR

Upcoming: August 26–30 7th Intl. Conf. on Advanced Materials, IUMRS; September 3–5 Intl. Workshop on Device Technology, MRS; September 12–14 Jornadas SAM-CONAMET 2001, MRS-A; September 19–21 MEMS: Materials Issues Workshop, MRS.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313.

MRS, A-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the May 2001 MRS BULLETIN for July 2001 Calendar entries.

AUGUST 2001

1–3 ▼ IMAPS Brazil Intl. Technical Symposium on Packaging and Assembling, São Paulo, Brazil. Executive Secretary, Eventuali; phone/fax 55-19-3233-9595; e-mail eventuali@bestway.com.br; www.imaps.org.

5–9 7th Intl. Colloquium on Atomic Spectra and Oscillator Strengths, Belfast, Northern Ireland, UK. A. Hibbert, Dept. of Applied Mathematics and Theoretical Physics, Queen's Univ., Belfast BT7 1NN, Northern Ireland, UK; 44-2890-273171; e-mail a.hibbert@qub.ac.uk; www.am.qub.ac.uk/asos7.

5–9 10th Intl. Conf. on Environmental Degradation of Materials in Nuclear Power Systems-Water Reactors, South Lake Tahoe, NV. NACE Intl., P.O. Box 218340, Houston, TX 77218-8340; 281-228-6223; e-mail msd@mail.nace.org; www.nace.org.

5–9 Conf. on Microscopy and Microanalysis, Long Beach, CA. MSA Meeting Managers, 7000 W. Southwest Hwy., Chicago Ridge, IL 60415; 708-361-6045; fax 708-361-6166; e-mail msa@tradeshownet.com; www.mmconference.org/2001.

6–8 26th Intl. Thermal Conductivity Conf. and 14th Intl. Thermal Expansion Symposium, Cambridge, MA. Conf. Chair, ITCC 26/ITES 14, c/o Holometrix Micromet, 25 Wiggins Ave., Bedford, MA 01730; itcc@holometrix.com; www.thermalconductivity.com.

6–10 6th Applied Diamond Conf./2nd Frontier Carbon Technology Joint Conf., Auburn, AL. www.eng.auburn.edu/department/ee/ADC-FCT2001/index.htm.

8–13 ▼ 4th Intl. Symposium on Electronic Packaging Technology, Beijing, China. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

12–16 13th Conf. on Crystal Growth and Epitaxy, Burlington, VT. T. Gentile, ACCGE-13 Secretariat, P.O. Box 3233, Thousand Oaks, CA 91359-0233; 805-492-7047; 805-492-4062; e-mail aacg@lafn.org; www.crystalgrowth.org/conferences/acgge13/.

12–17 10th Intl. Conf. on Phonon Scattering in Condensed Matter, Hanover, NH. Phonons 2001, Dept. of Physics and Astronomy, Dartmouth College, HB 6127, Hanover, NH 03755; e-mail phonons@mac.dartmouth.edu; www.dartmouth.edu/~phonon.

12–17 Conf. on Novel Synthesis and Processing of Nanostructured Coatings for Protection Against Degradation, Davos, Switzerland. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

13–17 10th Canadian Semiconductor Technology Conf., Ottawa, Ontario, Canada. M. Lanouette, Conf. Mgr., Conf. Services Office, Natl. Research Council Canada, Bldg. M-19, Ottawa, Ontario, Canada K1A 0R6; 613-993-0414; fax 613-993-7250; e-mail marie.lanouette@nrc.ca.

19–23 9th Intl. Symposium on Macromolecule Metal Complexes, Brooklyn, NY. N.L. Byerly, Div. of Polymer Chemistry, Virginia Tech, 410 Davidson Hall, MC 0279, Blacksburg, VA 24061; 540-231-3029; fax 540-231-2588; e-mail nbyerly@vt.edu; www.chem.umr.edu/~poly/poly.spon.html.

22–24 12th U.S. Natl. Synchrotron Radiation Instrumentation Conf., Madison, WI. Univ. of Wisconsin Synchrotron Radiation Ctr., 3731 Schneider Dr., Stoughton, WI 53589; 608-877-2000; fax 608-877-2001; e-mail SRI2001@src.wisc.edu; www.src.wisc.edu/SRI2001.

25–30 ▼ Euroconf. on Highly Branched Polymers, Dendrimers, and Multi-Component Polymer Networks, Helsinki, Finland. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

26–30 7th Intl. Conf. on Advanced Materials. Cancun, Mexico. M.L. Marquina, Dept. de Física, Facultad de Ciencias, Univ. Nacional Autónoma de México, 04510 México, D.F.; e-mail committee@icam2001.unam.mx; www.icam2001.unam.mx. IUMRS

26–30 222nd American Chemical Society Natl. Meeting, Chicago, IL. Dept. of Meetings, American Chemical Society, 1155-16th St., NW, Washington, DC 20036; 202-872-4396; fax 202-872-6128; e-mail natlmtgs@acs.org.

26–31 13th European Conference on Chemical Vapor Deposition (EUROCV13), Athens, Greece. www.imel.demokritos.gr/EUROCV13/Eurocvd13.html.

27–31 Conf. on Recrystallization and Grain Growth, Aachen, Germany. D.A. Molodov, Inst. für Metallkunde und Metallphysik, RWTH Aachen, D-52056 Aachen, Germany; fax 49-241-888-8608; e-mail ReX&GG@imm.rth-aachen.de.

SEPTEMBER 2001

2–7 200th Meeting of the Electrochemical Society and 52nd Meeting of the Intl. Society of Electrochemistry, San Francisco, CA. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

3–5 Intl. Workshop on Device Technology, Brazil. Israel Baumvol, Instituto de Física, Universidade Federal do Rio Grande do Sul, Av. Bento Gonçalves, 9500, 91509-900 Porto Alegre RS, Brazil; e-mail high-k@if.ufrgs.br. MRS.

3–7 ▼ 4th Iberoamerican Meeting of Optics, and 7th Latin American Meeting of Optics, Lasers, and Their Applications, Tandil, Argentina. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

3–7 9th Intl. Conf. on Ion Sources, Oakland, CA. M. Condon, Conf. Administrator; 510-486-7135; fax 510-486-5788; e-mail icis01@lbl.gov; http://icis01.lbl.gov.

3–7 10th Intl. Meeting on Ferroelectricity, Madrid, Spain. C. M. Jiménez, Jefe del Dept. de Electrocerámica, Inst. de Cerámica y Vidrio, CSIC, 28500 Arganda de Rey, Madrid, Spain; 34-91-871-1800; fax 34-91-870-0550; e-mail imf10@etsit.upm.es; www.imf10.etsit.upm.es.

3–7 11th Intl. Conf. on Radiation Effects in Insulators, Lisbon, Portugal. Conf. Secretariat REI-11, Inst. Tecnológico e Nuclear, Estrada Nacional No. 10, 2686-953, Sacavém, Portugal; 351-21-994-6000; fax 351-21-994-1525; e-mail REI-11@itn.pt; www.itn.pt/REI11/.

3–14 Conf. on Chemical Physics of Thin Film Deposition Processes for Micro- and Nano-Technologies, Kaunas, Lithuania. Y. Pauleau, CNRS-LEMD, B.P. 166, 25 Rue des Martyrs, 38042 Grenoble Cedex 9, France; 33-4-7688-1071; fax 33-4-7688-7945; e-mail pauleau@polycnrs-gre.fr; www.polycnrs-gre.fr.

5–7 ▼ Conf. on Nanostructure Science, Metrology, and Technology, Gaithersburg, MD. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

5–8 8th Biomedical Science and Technology Symposium, Ankara, Turkey. Dr. V. Hasirci, BIOMED 8, METU, Biological Sciences Dept., Ankara 06531, Turkey; 90-312-210-5180; fax 90-312-210-1289; e-mail biomed@metu.edu.tr; www.bio.metu.edu.tr/~biomed/new_page_1.htm.

7–12 Conf. on Electronic Structure of Solids and Surfaces, Giens, France. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; www.esf.org/euresco.

8–13 Conf. on Photovoltaic Devices: High-Efficiency Solar Cells, Tomar, Portugal. J. Hendekovic, European Science Foundation, 1 quai Lezay-Marnésia, 67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

8–13 ▼ Euroconf. on Interfaces and Thin Films of Polymers and Colloidal Systems, Acquafredda di Maratea (Naples), Italy. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

9–13 Power Quality Conf., Rosemont (Chicago), IL. Power Quality 2001, 2472 Eastman Ave. #33, Ventura, CA 93003-5792; fax 805-650-7054; e-mail linda@powersystems.com; www.powersystems.com/cfp/2001/pq.html.

9–14 10th Intl. Conf. on II-VI Compounds, Bremen, Germany. H. Heinke, Secretary II-VI 2001, Inst. for Solid State Physics, Univ. of Bremen, FB1, P.O. Box 330 440, D-28334 Bremen, Germany; 49-421-218-7453; fax 49-421-218-4581; e-mail II-VI2001@physik.uni-bremen.de; www.II-VI2001.uni-bremen.de.

9–14 Conf. on Surface Modification of Materials by Ion Beams, Marburg, Germany. D. Rueck, Gesellschaft für Schwerionenforschung mbH, Planckstrasse 1, D-64291 Darmstadt, Germany; 49-6159-71-2603; fax 49-6159-71-2505; e-mail D. Rueck@gsf.de; www.gsf.de.

9–14 Intl. Gordon Research Conf. on Superconductivity, Oxford, UK. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail grc@grcmail.grc.uri.edu; www.grc.uri.edu.

10–14 ▼ 4th Intl. Conf. on Atomic and Molecular Pulsed Lasers, Tomsk, Russia. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

10-14 ▼ 4th Yugoslav Materials Research Society Conf., *Herceg Novi, Yugoslavia*. Yugoslav Materials Research Society, Knez Mihailova 35/IV, 11000 Belgrade, Yugoslavia; 381-11-185-437; fax 381-11-185-263; e-mail uskok@itn.sanu.ac.yu; www.yu-mrs.org.yu.

11-12 ▼ Dielectric Science and New Functionality in Device Physics for Crystalline Oxides on Semiconductors, *Chattanooga, Tennessee*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

11-14 Intl. Symposium on High-Performance Liquid Phase Separation, *Kyoto, Japan*. N. Tanaka, Kyoto Inst. of Technology, Kyoto, Japan; e-mail hplckit@ipc.kit.ac.jp.

11-16 ▼ Euroconf. on the Deposition of Atoms, Ions, and Clusters at Surfaces, *San Sebastian, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

12-14 2nd Intl. Conf. on High-Resolution and Magnetic Sector Field ICP-MS, *Vienna, Austria*. T. Prohaska, Inst. für Chemie, Univ. für Bodenkultur, BOKU-Wien, Muthgasse 18, A-1190 Vienna, Austria; 43-1-36006-6092; fax 43-1-36006-6059-092; e-mail prohaska@mail.boku.ac.at; www.boku.ac.at/chemie/conferences/conferences.htm.

12-14 European Society for Biomaterials Conf., *London, UK*. D. Gornall, Biomaterials 2001 Secretariat, IRC in Biomedical Materials, Queen Mary Univ. of London, Mile End Rd., London E1 4NS, UK; 44-20-7882-5318; fax 44-20-8983-1799; e-mail ESB2001@qmw.ac.uk; www.irc-biomed-materials.qmw.ac.uk.

12-14 **Jornadas SAM-CONAMET 2001**, *Pasodas, Argentina*. Jornadas SAM-CONAMET 2001, Facultad de Ciencias Exactas, Químicas y Naturales, Azara 1552, 3300 Posadas, Misiones, Argentina. **MRS-A.**

14-16 4th Intl. Conf. on Peer Review in Biomedical Publication, *Barcelona, Spain*. A. Flanagin, JAMA, 515 N. State St., Chicago, IL 60610; 312-464-2432; fax 312-464-5824; e-mail jama-peer@ama-assn.org.

15-20 ▼ Euroconf. on the Physics of Atomic Gases at Low Temperatures, *San Feliu de Guixols, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

16-21 11th Intl. Workshop on Glasses, Ceramics, Hybrids, and Nanocomposites from Gels, *Padova, Italy*. Workshop Sol-Gel 2001, c/o Dipartimento di Ingegneria Meccanica, Settore Materiali, via Marzolo 9, 35131 Padova, Italy; 39-49-827-5514; fax 39-49-8275505; e-mail solgel/01@ux1.unipd.it.

16-21 Intl. Conf. on Hydrogen Effects on Material Behavior and Corrosion Deformation Interactions, *Moran, WY*. N.R. Moody, SNL, P.O. Box 969, MS-9404, Livermore, CA 94551; 925-294-2622; fax 925-294-3410. **Endorsed.**

16-21 Intl. Gordon Research Conf. on Solid State Chemistry II, *Oxford, UK*. Gordon Research Conferences, P.O. Box 984, West Kingston, RI 02892-0984; 401-783-4011; fax 401-783-7644; e-mail grc@grcmail.grc.uri.edu; www.grc.uri.edu.

17-20 5th Intl. Airborne Remote Sensing Conf., *San Francisco, CA*. Veridian Systems Intl. Conferences, P.O. Box 134008, Ann Arbor, MI 48113-4008; 734-994-1200; fax 734-994-5123; www.irim-int.com/CONF/IARSC.html.

17-21 Conf. on X-Ray and Neutron Capillary Optics, *Zvenigorod, Russia*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

17-21 Intl. Symposium on Advanced Materials, *Islamabad, Pakistan*. A.A. Mazhar, Secretary Symposium, A.Q. Khan Res. Lab., Kahuta, P.O. Box 905, Rawalpindi, Pakistan, 92-51-928-0541; fax 92-51-928-0542; e-mail compudiv@asb.paknet.com.pk.

18-21 Intl. Conf. on Advances in Materials and Processing Technologies, *Madrid, Spain*. AMPT'01 Congress Secretariat, Fundación Univ. Carlos III, CON-GREGA, Avda. de la Universidad 30, 28911 Leganés, Spain; 34-91-624-9142; fax 34-91-624-9147; e-mail congrega@fund.uc3m.es; e-mail ampt01@ing.uc3m.es.

19-21 ▼ 2nd Georgia Tech Conf. on Nanoscience and Nanotechnology, *Atlanta, GA*. Georgia Inst. of Technology, Continuing Education, P.O. Box 93686, Atlanta, GA 30377-0686; 404-385-3501; fax 404-894-8925; e-mail conted@gatech.edu; www.conted.gatech.edu/programs/conferences_and_symposiums.

19-21 **MEMS: Materials Issues Workshop**, *Miami, FL*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

20-21 9th Intl. Activated Carbon Conf., *Pittsburgh, PA*. H. Nowicki, PACS, Inc., 409 Meade Dr., Coraopolis, PA 15108; 800-367-2587; fax 724-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs.htm.

22-25 ▼ 2nd BioMEMS and Biomedical Nanotechnology World Meeting, *Columbus, OH*. C. Lingham, Cambridge Healthtech Inst., 1037 Chestnut St., Newton Upper Falls, MA 02464; 617-630-1364; fax 617-630-1325; e-mail clingham@healthtech.com; www.healthtech.com.

22-27 ▼ Conf. on Chemical Building Blocks for New Materials, *Acquafredda di Maratea (Naples), Italy*. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

23-26 ▼ 38th IMAPS Nordic Conf., *Oslo, Norway*. IMAPS Nordic, P.O. Box 277, SE-431 24 Mölndal, Sweden; fax 46-19-567070; e-mail info@imapsnordic.a.se; www.imapsnordic.a.se.

23-26 Engineering Materials Conf., *Melbourne, Australia*. Secretariat, IMEA Head Office; 61-3-9326-7266; fax 61-3-9326-7272; e-mail imea@mateng.asn.au; www.mateng.asn.au/engmat2001.

23-26 TMS Fall Extraction and Process Metallurgy Meeting, *San Diego, CA*. M. Cross, School of Computing and Mathematical Science, Univ. of Greenwich, Woolwich Campus, Wellington St., Woolwich, London SE18 6PF, UK; 44-208-331-8702; fax 44-208-331-8695.

23-27 3rd Intl. Symposium on Structural Intermetallics, *Jackson Hole, WY*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail tmsgeneral@tms.org; www.tms.org/meetings/.

23-27 6th World Congress of Chemical Engineering, *Melbourne, Australia*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

23-27 ACS Southeast Regional Meeting, *Savannah, GA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

24-28 9th Intl. Conf. on Defects: Recognition, Imaging, and Physics in Semiconductors, *Rimini, Italy*. C. Frigeri, CNR-MASPEC, Parco Area delle Scienze, 37/A, Fontanini, 43010 Parma, Italy; 39-521-269-235; fax 39-521-269-206; e-mail frigeri@maspec.bo.cnr.it; www.maspec.bo.cnr.it/ut/d11200/NEWS/drip9/drip9.html.

29-4 ▼ Euroconf. on Short Pulse, Superstrong Laser-Plasma Interactions, *San Feliu de Guixols, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

30-5 Conf. on Nonstoichiometric Ceramics and Intermetallics, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

OCTOBER 2001

1-3 Conf. on Fine Powder Processing, *State College, PA*. C. Knobloch, Particle Materials Ctr., The Pennsylvania State Univ., 225 Materials Research Lab., University Park, PA 16802-4801; 814-863-6156; fax 814-863-9704; e-mail clk18@psu.edu; conferenceinfo@cde.psu.edu.

1-3 Intl. Conf. on Process Modeling and Powder Metallurgy & Particulate Materials, *Irvine, CA*. Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpfif.org.

1-3 ▼ Symposium on Optical Materials for High Power Lasers, *Boulder, CO*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

1-4 Materialica Conf., *Munich, Germany*. Messe München GmbH, Zentralbereich Presse- und Öffentlichkeitsarbeit, Presserelaterat MATERIALICA, Messgelände, D-81823 München, Germany; 49-89-9-49-20650; fax 49-89-9-49-20659; e-mail info@materialica.de; www.materialica.de.

3-5 ▼ 2001 U.S. Workshop on the Physics and Chemistry of II-VI Materials, *Orlando, FL*. J. Lee, Palisades Convention Mgmt.; 212-460-8090; fax 212-460-5460; www.ii-viworkshop.org.

3-5 Conf. on Photomask Technology and Management, *Monterey, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

5-12 28th Annual Conf. on Federation of Analytical Chemistry and Spectroscopy Societies, *Detroit, MI*. C. Lilly, FACSS Natl. Office, 1201 Don Diego Ave., Santa Fe, NM 87505; 505-820-1648; fax 505-989-1073; e-mail jsjoberg@trail.com; http://facss.org/info.html.

6-11 ▼ Euroconf. on Quantum Optics, *San Feliu de Guixols, Spain*. European Science Foundation, 1 quai Lezay-Marnésia, F-67080 Strasbourg Cedex, France; 33-388-76-71-35; fax 33-388-36-69-87; e-mail euresco@esf.org; www.esf.org/euresco.

7-10 Conf. on Advances in Polyolefins III, *Sonoma, CA*. J.E. McGrath, Dept. of Chemistry, Virginia Tech, Blacksburg, VA 24061; 540-231-5976; fax 540-231-8517; e-mail jmcgrath@vt.edu; www.chem.umr.edu/~poly/poly.spon.html.

7-12 ▼ 16th Conf. on Enzyme Engineering, *Potsdam, Germany*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

7-12 Conf. on Structural Ceramics and Ceramic Composites for High-Temperature Applications, *Seville, Spain*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org.

8-10 ▼ Intl. Workshop on Photonics and Imaging in Biology and Medicine, *Wuhan, China*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

9-11 Advanced Metallization Conference (AMC), *Montreal, Canada*. Continuing Education in Engineering, UC Berkeley Extension, 1995 University Avenue, Berkeley, CA 94720-7010, USA; 510-642-4151; fax 510-642-6027; e-mail course@unx.berkeley.edu; www.unex.berkeley.edu/eng/metall.

9-11 ▼ Intl. Symposium on Microelectronics, *Baltimore, MD*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

9-12 ▼ 54th Annual Gaseous Electronics Conf., *State College, PA*. R. McGrath, Conf. Secretary, Penn State Univ., 304 Old Main, University Park, PA 16802; 814-863-9580; fax 814-863-9659; e-mail mcgrath@psu.edu.

10-13 ACS Midwest Regional Meeting, *Lincoln, NE*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

11-14 ▼ Advanced Technology Workshop on Optoelectronics Packaging, *Bethlehem, PA*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

12-17 ▼ China Hi-Tech Fair on Advanced Materials, *Shenzhen, China*. China Hi-Tech Transfer Ctr., Shenzhen, China; 86-755-3065436; fax 86-755-3065471; e-mail cathyh@chtf.com; www.chtf.com.

13 2nd Dartmouth Molecular Materials Symposium, *Hanover, NH*. Dartmouth Molecular Materials Group, Dartmouth College, 6128 Burke Lab., Hanover, NH 03755-3564; 603-646-2710; fax 603-646-3946; e-mail dmmg@dartmouth.edu; www.dartmouth.edu/~dmmg/Oct.Symposium.html.

14-18 6th Intl. Symposium on Self-Propagating High-Temperature Synthesis, *Haifa, Israel*. Dept. of Materials Engineering, TECHNION-Israel Inst. of Technology, Technion City, Haifa 32000, Israel; 972-4-829-2112; fax 972-4-832-1978; e-mail gutmanas@tx.technion.ac.il; www.technion.ac.il/technion/materials.

14-18 17th Interdisciplinary Laser Science Conf., *Long Beach, CA*. OSA Conf. Services, 2010 Massachusetts Ave. N.W., Washington, DC 20036-1023; 202-223-0920; fax 202-416-6100; e-mail onfserv@osa.org; www.osa.org/annual.

14-19 ▼ Conf. on Advanced Membrane Technology, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

15-18 20th Intl. Congress on Applications of Lasers and Electro-Optics, *Jacksonville, FL*. B. Cohen, Laser Inst. of America, 13501 Ingenuity Dr., Ste. 128, Orlando, FL 32826; 407-380-1553; fax 407-380-5588; e-mail lia@laserinstitute.org; www.icaleo.org.

16-17 Conf. on Power Transmission Components—Advances in High-Performance Powder Metallurgy Applications, *Ypsilanti, MI*. Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpif.org.

16-19 ▼ Intl. Symposium on Optical Memory, *Taipei, Taiwan*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

17-19 ▼ 2nd Annual LED Conf., *San Diego, CA*. J. Olmstead, Conf. Director, Intertech Corp., 19 Northbrook Dr., Portland, ME 04105; 207-781-9615; fax 207-781-2150; e-mail jonathan@intertechusa.com; www.intertechusa.com.

17-20 ACS Southwest Regional Meeting, *San Antonio, TX*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

17-20 Fall Meeting of the APS Division of Nuclear Physics, *Maui, HI*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; www.aps.org.

21-25 Intl. Workshop on Flow and Fracture of Advanced Glasses, *Rennes, France*. V. Keryvin, Univ. Rennes1, Larmaur, 35042 Rennes, France; 33-2-9928-2685; fax 33-2-9928-1600; e-mail vincent.keryvin@univ-rennes1.fr; www.larmaur.univ-rennes1.fr/fag.

22-23 North American Orbital Welding Symposium, *Rosemont, IL*. Astro Arc Polysoude, W133 N5138 Campbell Dr., Menomonee Falls, WI 53051; 414-783-2720; fax 414-783-2730; e-mail mbaer@polysoude.com; www.polysoude.com.

22-24 4th Biennial Conf. on Emulsion Polymers/Polymer Colloids, *Orlando, FL*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 845-255-0757; fax 845-255-0978; e-mail info@ims-np.org; http://ims-hp.org.

22-24 Powder Metallurgy Congress, *Nice, France*. European Powder Metallurgy Assoc., Old Bank Bldgs., Bellstone, Shrewsbury SY1 1HU, UK; 44-1743-248-899; fax 44-1743-362-968; e-mail info@epma.com; www.epma.com.

22-26 OSA Annual Meeting and 16th Interdisciplinary Laser Science Conf., *Providence, RI*. Optical Society of America, Conf. Services Dept., 2010 Massachusetts Ave., NW, Washington, DC 20036-1023; 202-223-8130; fax 202-223-1096; e-mail confserv@osa.org; www.osa.org/mtg_conf/annual.

25-26 8th Sampling, On-Site Analysis, and Sample Preparation Conf., *Pittsburgh, PA*. B. Sherman, PACS, Inc., 409 Meade Dr., Coraopolis, PA 15108-9616; 800-367-2587; fax 724-457-1214; e-mail hnpacs@aol.com; http://members.aol.com/hnpacs/pacs.htm.

28-31 43rd Mechanical Working and Steel Processing Conf., *Charlotte, NC*. Iron & Steel Society, 186 Thorn Hill Rd., Warrendale, PA 15086-7528; 724-776-1535; fax 724-776-0430; e-mail custserv@iss.org; www.iss.org.

28-31 ACS Western Regional Meeting, *Santa Barbara, CA*. American Chemical Society, 1115 16th St., NW, Washington, DC 20036; 202-872-4600; fax 202-872-4615; e-mail help@acs.org; www.acs.org.

28-2 Intl. Conf. on Silicon Carbide and Related Materials, *Tsukuba, Japan*. H. Okumura, Electrotechnical Lab., 1-1-4 Umezono, Tsukuba, Ibaraki 305-8565, Japan; www.icscr2001.gr.jp/.

29-2 48th Natl. American Vacuum Society Symposium, *San Francisco, CA*. American Vacuum Society Natl. Office, 120 Walls St., 32nd Fl., New York, NY 10005; 212-248-0200; fax 212-248-0245; e-mail avsnyc@vacuum.org; www.vacuum.org.

29-2 Meeting of the APS Div. of Plasma Physics, *Long Beach, CA*. APS Headquarters, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

30-31 ▼ 4th Conf. on Materials for Lean Weight Vehicles, *Gaydon, UK*. L. Bromley, IOM Communications, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-20-7451-7302; fax 44-20-7839-2289; e-mail Lisa_Bromley@materials.org.uk.

NOVEMBER 2001

4-8 33rd Intl. SAMPE Technical Conf., *Seattle, WA*. Society for the Advancement of Material and Process Engineering, P.O. Box 2459, Covina, CA 91722-8459; 626-331-0616; fax 626-332-8929; e-mail sampereg@aol.com; www.sampe.org.

4-8 Intl. Conf. on Advanced Ceramics and Glasses, *Maui, HI*. American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.acers.org/meetings/.

4-8 TMS Fall Meeting, *Indianapolis, IN*. TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org.

4-9 AIChE Annual Meeting, *Reno, NV*. Meetings Dept., American Inst. of Chemical Engineers, 3 Park Ave., New York, NY 10016-5991; 212-591-7338; fax 212-591-8894; e-mail meetmail@aiche.org; www.aiche.org/conferences/.

5-7 2nd Intl. Symposium on Adhesion Aspects of Thin Films, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rh@mstconf.com; http://mstconf.com/adhtf2.htm.

7-9 3rd Intl. Symposium on Adhesion Measurement of Thin Films and Coatings, *Newark, NJ*. R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rh@mstconf.com; http://mstconf.com/adhmeas3.htm.

7-10 ▼ Intl. Symposium on Optoelectronics and Microelectronics, *Nanjing, China*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

11-14 59th Electric Furnace Conf., *Phoenix, AZ*. The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-794-5890; fax 614-899-6109; e-mail customersrv@acers.org; www.ceramics.org.

11-16 ASME Intl. Mechanical Engineering Congress, *New York, NY*. American Society of Mechanical Engineers, 3 Park Ave., New York, NY 10016-5990; 1-800-843-2763; e-mail www.infocentral@asme.org; www.asme.org.

11-16 Conf. on Integrating Materials Science into Engineering Structures and Devices, *Lake Arrowhead, CA*. United Engineering Foundation, 3 Park Ave., 27th Floor, New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.engfnd.org/engfnd/lar/html.

12-16 45th Annual Magnetism and Magnetic Materials Conf., *Seattle, WA*. 2001 MMM Conf., Courtesy Associates, 2000 L St. N.W., Ste. 710, Washington, DC 20036; 202-973-8668; fax 202-973-8722; e-mail magnetism@courtesyassoc.com; www.magnetism.org.

14-16 ▼ 3rd Intl. Conf. on Organic Light Emissive Devices, *San Diego, CA*. J. Scheld, Intertech Conferences, 19 Northbrook Dr., Portland, ME 04105; 207-781-9800; fax 207-781-2150; e-mail info@intertechusa.com; www.intertechusa.com.

14-17 Conf. on Organic/Inorganic Hybrid Materials, *Sonoma, CA*. www.chem.umn.edu/~poly/poly.spon.html.

26-27 ▼ MMC VIII Metallic Composites and Foams, *London, UK*. L. Bromley, IOM Communications, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-20-7451-7302; fax 44-20-7839-2289; e-mail Lisa_Bromley@materials.org.uk.

26-30 ▼ Intl. Symposium on Photonics and Applications, *Singapore*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

26-30 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

27-30 Intl. Conf. on Accelerator and Large Experimental Physics, *San Jose, CA.* ICALEPCS 2001 Secretariat, Centennial Conferences, 4800 Baseline Rd., Ste. A-112, Boulder, CO 80303; 303-499-2299; fax 303-499-2599; e-mail icalpecs@centennialconferences.com; http://icalpecs2001.slac.stanford.edu/

DECEMBER 2001

2-5 ▼ Niobium Conf., *Orlando, FL.* D.G. Howden, 3285 Wilson Rd., P.O. Box 544, Sunbury, OH 43074-0544; fax 740-965-2366; e-mail niobium2001@worldnet.att.net.

3-5 2nd Intl. Symposium on Polyimides and Other High Temperature Polymers, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/polyim2.htm.

3-6 ▼ Australasian Conf. on Optics and Laser Spectroscopy, *Brisbane, Queensland, Australia.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

3-7 10th Intl. Congress of Fracture, *Honolulu, HI.* A. Hill, ICF10 Congress Secretariat, Elsevier Science, The Boulevard, Langford Lane, Kidlington, Oxford OX5 1GB, UK; 44-1865-843-643; fax 44-1865-843-958; e-mail a.richardson@elsevier.co.uk; www.elsevier.com.

3-7 Pacific Polymer Federation Conf., *Oaxaca City, Mexico.* T. Ogawa, Inst. de Investigaciones en Materiales, UNAM, Ap. 70-360, CU, Coyoacan, Mexico DF 04510, Mexico; 52-5-622-4583; fax 52-5-616-1201; e-mail ogawa@servidor.unam.mx; www.chem.umr.edu/~poly/poly.spon.html.

5-7 ▼ Intl. Semiconductor Device Research Symposium, *Georgetown, Washington, DC.* A. Iliadis, ISDRS '01 Symposium Chair, Dept. of Electrical and Computer Engineering, Univ. of Maryland, College Park, MD 20742; e-mail agis@eng.umd.edu; www.ece.umd.edu/ISDRS_2001.

5-8 3rd Intl. Symposium on Environmental Hydraulics, *Tempe, AZ.* R. Rankin, ISEH 2001 Secretary, Arizona State Univ., Dept. of Mechanical and Aerospace Engineering, P.O. Box 876106, Tempe, AZ 85287-6106; 480-965-3207; fax 480-965-1384; e-mail iseh@enpop2.eas.asu.edu; www1.eas.asu.edu/~iseh2001/.

6-7 8th Intl. Symposium on Metallized Plastics, *Newark, NJ.* R.H. Lacombe, Conf. Chairman, 3 Hammer Dr., Hopewell Junction, NY 12533; 845-226-1393; fax 212-656-1016; e-mail rhl@mstconf.com; http://mstconf.com/metaplas8.htm.

11-15 4th Pacific Rim Intl. Conf. on Advanced Materials and Processing, *Honolulu, HI.* S. Hanada, Tohoku Univ., Inst. for Materials Research, Katahira 2-1-1, Aoba-ku, Sendai 980-8577, Japan; 81-22-215-2115; fax 81-22-215-2116; e-mail ccpricm4@imr.tohoku.ac.jp.

11-15 ▼ 11th Intl. Workshop on the Physics of Semiconductor Devices, *New Delhi, India.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

17-19 ▼ Intl. Symposium on Microelectronics and MEMS, *Adelaide, Australia.* SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; www.spie.org.

JANUARY 2002

6-11 13th Intl. Conf. on Ternary and Multinary Compounds, *Dead Sea, Israel.* D. Cahen, Dept. of Materials and Interfaces, Weizmann Inst. of Science, Rehovoth, Israel 76100; 972-0-89-34-2246; fax 972-0-89-34-4139; e-mail david.cahen@weizmann.ac.il; www.weizmann.ac.il/material/.

6-12 Winter Conf. on Plasma Spectrochemistry, *Scottsdale, AZ.* R. Barnes, ICP Information Newsletter, Inc., P.O. Box 666, Hadley, MA 01003-0666; 413-256-8942; fax 413-256-3746; e-mail winterconf@chem.umass.edu; www.chem.umass.edu/WinterConf2002.

13-17 ▼ Conf. on Thermal Challenges in Next Generation Electronic Systems, *Santa Fe, NM.* United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

13-18 ▼ 26th Annual Intl. Conf. on Advanced Ceramics and Composites, *Cocoa Beach, FL.* Technical Program Coordinator, American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; fax 614-794-5882; e-mail jdavis@acers.org.

23-25 ▼ 2nd Intl. Colloquium on Modeling of Glass Forming and Tempering, *Valenciennes, France.* P. Moreau, Colloquium Organizer, M.G.F.T. 2002, L.A.M.I.H/L.G.M., Univ. de Valenciennes et du Hainaut-Cambresis, 59313 Valenciennes Cedex 9, France; 33-3-27-51-13-84; fax 33-3-27-51-13-17; e-mail philippe.moreau@univ-valenciennes.fr; www.univ-valenciennes.fr.

FEBRUARY 2002

1-3 Intl. Conf. on Advances in Materials and Materials Processing, *Kharagpur, India.* Dept. of Metallurgical and Materials Engineering, Indian Inst. of Technology, Kharagpur 721 302, India; 91-3222-82280; fax 91-3222-55303; e-mail icamp@metal.iitkgp.ernet.in.

17-21 TMS Annual Meeting, *Seattle, WA.* TMS, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail weissp@tms.org; www.tms.org/meetings/.

MARCH 2002

2-3 Conf. on Film Formation: Mechanism, Properties, and Characterization, *Hilton Head, SC.* Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; e-mail info@ims-np.org; http://ims-np.org/.

2-3 Conf. on Polymer Degradation and Stabilization, *Hilton Head, SC.* Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org/.

4-6 4th Biennial Conf. on Polymer Stabilizers and Modifiers, *Hilton Head, SC.* Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org/.

4-6 Conf. on Film Formation: Science and Technology, *Hilton Head, SC.* Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org/.

11-13 ▼ Intl. Conf. on High-Performance Structures and Composites, *Seville, Spain.* Conf. Secretariat, HPSC 2002, Wessex Inst. of Technology, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK; 44-2380-293223; fax 44-2380-292853; e-mail shanley@wessex.ac.uk; www.wessex.ac.uk/conferences/2002/hps02.

17-20 ▼ 7th Intl. Multidisciplinary Conf. on Complexity and Fractals in the Sciences, *Granada, Spain.* M.M. Novak, School of Mathematics, Kingston Univ., Penrhyn Rd., Surrey KT1 2EE, UK; www.kingston.ac.uk/fractal/.

18-22 APS March Meeting, *Indianapolis, IN.* American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

18-22 Intl. Solvent Extraction Conf., *Cape Town, South Africa.* Conf. Secretariat, Private Bag X3015, Randburg 2125, South Africa; 27-11-709-4255; fax 27-11-709-4326; e-mail isec2002@mintek.co.za; www.isec2002.org.za.

APRIL 2002

1-5 **MRS Spring Meeting, San Francisco, CA.** Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

3-5 ▼ Intl. Conf. on High-Density Interconnect and Systems Packaging, *Santa Clara, CA.* Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

8-10 ▼ Intl. Conf. on Metal Powder Deposition for Rapid Manufacturing, *San Antonio, TX.* S.E. Leatherman, Technical Programs Mgr., Metal Powder Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

9-11 ▼ Materials Congress 2002, *London, UK.* V. Morrison, IOM Communications, 1 Carlton House Terrace, London SW1Y 5DB, UK; 44-20-7451-7340; fax 44-20-7839-2289; www.materials.org.uk/congress2002/intro.htm.

28-1 104th ACerS Annual Meeting, *St. Louis, MO.* The American Ceramic Society, P.O. Box 6136, Westerville, OH 43086-6136; 614-890-4700; fax 614-899-6109; e-mail info@acers.org; www.ceramics.org.

29-2 ▼ Intl. Conf. on Characterization and Metrology for ULSI Technology, *Gaithersburg, MD.* L. Printz, NIST, Gaithersburg, MD 20899; e-mail lori.printz@nist.gov; www.eeel.nist.gov/812/conference/Endorsed.

MAY 2002

6-7 ▼ Intl. Conf. on Functionally Graded Materials, *Denver, CO.* S. Leatherman, Technical Programs Mgr., Metal Power Industries Federation, 105 College Rd. East, Princeton, NJ 08540-6692; 609-452-7700; fax 609-987-8523; e-mail leatherm@mpif.org; www.mpif.org.

12-17 201st Meeting of the Electrochemical Society, *Philadelphia, PA.* The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

27-29 7th European Symposium on Polymer Blends, *Lyon-Villeurbanne, France.* Secretariat, 7th European Symposium on Polymer Blends, Lab. des Matériaux Macromoléculaires, Bat J. Verne, INSA Lyon, 20 Ave. Albert Einstein, 69621, Villeurbanne Cedex, France; 33-4-72-43-8527; e-mail polymerblends@insa-lyon.fr; www.insa-lyon.fr/polymer_blends/index.htm.

JUNE 2002

10-14 8th Intl. Conf. on Electronic Materials, *Xi'an, China.* J. Cheng; 86-10-6894-4280; fax 86-10-6842-8640; e-mail cmrsec@public.bta.net.cn; www.c-mrs.org.cn/icem2002/.

C-MRS.

16-18 ▼ European IMAPS Symposium, *Cracow, Poland*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

16-20 Intl. Cryogenic Materials Conf., *Xi'an, China*. Y. Feng, Northwest Inst. for Non-ferrous Metal Research, P.O. Box 51, Xi'an, Shaanxi 710016, China; 86-29-623-1079; fax 86-29-623-1103; e-mail smrc@pub.xaonline.com.

17-20 ▼ 1st Intl. Conf. on Multiscale Materials Modeling, *London, UK*. MMM Local Organising Committee, Dept. of Materials, Queen Mary, Univ. of London, London E1 4NS, UK; 44-20-7882-5159; fax 44-20-8981-9804; e-mail x.guo@qmw.ac.uk; www.multiscalemodelling.com.

23-26 Intl. Conf. on Thermomechanical Processing, *Sheffield, UK*. Thermomechanical Processing: Mechanics, Microstructure, and Control, c/o IMMPEUS Admin. Office, Univ. of Sheffield, Sir Frederick Mappin Bldg., Mappin St., Sheffield S1 3JD, UK; 44-114-222-6018; fax 44-114-222-6015; e-mail tpmmc@sheffield.ac.uk; http://dyn052176.shef.ac.uk/conference_2002.

23-28 11th Intl. Meeting on Lithium Batteries, *Monterey, CA*. IMLB 11 Conf. Secretariat, c/o The Electrochemical Society, Inc., 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org/meetings/011/imlb11.html.

26-28 ▼ Electronic Materials Conf., *Santa Barbara, CA*. TMS Meetings Services, 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings.

JULY 2002

1-5 Conf. on Coatings Science and Technology, *Athens, Greece*. Inst. of Materials Science, Div. of Program Organization, P.O. Box 369, New Paltz, NY 12561; 914-255-0757; fax 914-255-0978; e-mail info@ims-np.org; http://ims-np.org/.

1-5 Intl. Conf. on Fuel Cells, *Lucerne, Switzerland*. European Fuel Cell Forum, P.O. Box 99, CH-5452 Oberrohrdorf, Switzerland; 41-56-496-7292; fax 41-56-496-4412; e-mail info@efcf.com; www.efcf.com.

14-18 13th Intl. Symposium on Transport Phenomena, *Victoria, BC, Canada*. S. Dost, ISTP-13, Dept. of Mechanical Engineering, Univ. of Victoria, Victoria, BC, Canada V8W 3P6; 250-721-8898; fax 250-721-6294; e-mail istp13@uvic.ca; www.istp13.uvic.ca.

14-19 ▼ CIMTEC Intl. Conf. on Materials and Technologies: 10th Intl. Ceramics Congress and 3rd Forum on New Materials, *Florence, Italy*. CIMTEC 2002 Secretariat, P.O. Box 174, 48018 Faenza, Italy; 39-546-22461; fax 39-546-664138; www.dinamica.it/cimte.

14-19 ▼ Conf. on Polymer Colloids: Preparation and Properties of Aqueous Polymer Dispersions, *Irsee, Germany*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

29-2 26th Intl. Conf. on the Physics of Semiconductors, *Edinburgh, Scotland*. Conf. Dept., ICPS2002, Inst. of Physics, 76 Portland Place, London W1B 1NT, England; 44-20-7470-4800; fax 44-20-7470-4900; www.icps2002.org.

AUGUST 2002

18-23 ▼ Intl. Conf. on Electrophoretic Deposition: Fundamentals and Applications, *Banff, Canada*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

25-29 ▼ Conf. on Fluid Particle Interactions, *Barga, Italy*. United Engineering Foundation, 3 Park Ave., New York, NY 10016-5902; 212-591-7836; fax 212-591-7441; e-mail engfnd@aol.com; www.uefoundation.org.

28-31 ▼ 2nd Intl. Mould & Die Making and Manufacturing Technology Exhibition for Asia, *Hong Kong*. Business and Industrial Trade Fairs Ltd., Unit 1223, HITEC, 1 Trademart Dr., Kowloon Bay, Hong Kong; 852-2865-2633; fax 852-2866-1770; e-mail enquiry@bitf.com.hk.

SEPTEMBER 2002

4-6 ▼ 35th Intl. Symposium on Microelectronics, *Denver, CO*. Intl. Microelectronics And Packaging Society, 611 2nd St. NE, Washington, DC 20002; 202-548-4001; fax 202-548-6115; www.imaps.org.

8-12 6th Intl. Meeting on Magnetic Resonance in Porous Media, *Ulm, Germany*. www.uni-ulm.de/nmr/mrpm/early_notification.htm.

16-20 ▼ Intl. Conf. on Shot Peening, *Garmisch-Partenkirchen, Germany*. P. Schepp, Deutsche Gesellschaft für Materialkunde e.V., Hamburger Allee 26, D-60486 Frankfurt, Germany; 49-69-7917-750; fax 49-69-7917-733; e-mail shot-peening@dgm.de; www.dgm.de/shot-peening.

24-27 3rd World Congress on Emulsions, *Lyon, France*. CME, 50 Place Marcel Pagnol, 92100 Boulogne-Billancourt, France; 33-147-617-689; fax 33-147-617-465; e-mail alain.lecoroller@wanadoo.fr; www.cme-emulsion.com.

OCTOBER 2002

6-10 TMS Fall Meeting, *Columbus, OH*. TMS Programming Dept., 184 Thorn Hill Rd., Warrendale, PA 15086; 724-776-9000; fax 724-776-3770; e-mail kcobert@tms.org; www.tms.org.

20-25 202nd Meeting of the Electrochemical Society, *Salt Lake City, UT*. The Electrochemical Society, 65 S. Main St., Pennington, NJ 08534-2839; 609-737-1902; fax 609-737-2743; e-mail ecs@electrochem.org; www.electrochem.org.

NOVEMBER 2002

11-15 44th Annual Meeting of the APS Division of Plasma Physics, *Orlando, FL*. American Physical Society, One Physics Ellipse, College Park, MD 20740-3844; 301-209-3200; fax 301-209-0865; e-mail meetings@aps.org; www.aps.org.

DECEMBER 2002

2-6 MRS Fall Meeting, *Boston, MA*. Materials Research Society, 506 Keystone Dr., Warrendale, PA 15086-7573; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

VII International Conference on Advanced Materials, ICAM 2001

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Nanostructures, magnetic materials, fracture mechanics, thin films, semiconductors, biomaterials, computer simulations, sol-gel, synthesis, steelmaking, polymers, ceramics, surface engineering, quantum dots, fullerenes, liquid crystals, catalysis, archaeological materials, tunneling, glasses, cements, superconductivity, corrosion, material characterization, metals, alloys and phase transitions, amorphous materials, renewable-energy materials, composites, recycling materials, and optical properties.

Information: María Luisa Marquina, Departamento de Física, Facultad de Ciencias, Universidad Nacional Autónoma de México, 04510 México, D.F.

committee@icam2001.unam.mx

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